

C3M0120065D

Silicon Carbide Power MOSFET C3M[™] MOSFET Technology

N-Channel Enhancement Mode

Features

- 3rd Generation SiC MOSFET technology
- High blocking voltage with low on-resistance
- High speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q_{rr})
- Halogen free, RoHS compliant



- Solar inverters
- DC/DC converters
- Switch Mode Power Supplies
- EV battery chargers
- UPS

RoHS (1) (2) (2) ROHS (3) Halogen-Free

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Ordering Part Number	Package	Marking	
C3M0120065D	TO-247-3	C3M0120065D	

Benefits

- Higher system efficiency
- Reduced cooling requirements
- Increased power density
- Increased system switching frequency
- Easy to parallel and simple to drive
- Enable new hard switching PFC topologies (Totem-Pole)

Key Parameters

Parameter	Symbol	Min.	Тур.	Мах	Unit	Conditions	Note
rain - Source Voltage V _{DS}				650	V	T _c = 25°C	
Maximum Gate - Source Voltage	ge V _{GS(max)}			+19		Transient	
Operational Gate-Source Voltage	V _{GS op}		-4/15			Static	Note 1
DC Continuous Drain Current				22		$V_{GS} = 15 \text{ V}, \text{ T}_{C} = 25 \text{ °C}, \text{ T}_{J} \le 175 \text{ °C}$	Fig. 19 Note 2
	I _D			16	А	$V_{GS} = 15 \text{ V}, \text{ T}_{C} = 100 \text{ °C}, \text{ T}_{J} \le 175 \text{ °C}$	
Pulsed Drain Current	I _{DM}			51		t_{Pmax} limited by T_{jmax} $V_{GS} = 15V, T_{C} = 25 \text{ °C}$	Fig. 22
Power Dissipation	P _D			98	w	$T_{c} = 25^{\circ}C, T_{J} = 175^{\circ}C$	Fig. 20
Operating Junction and Storage Temperature	T _J , T _{stg}			-40 to +175	°C		
Solder Temperature	Τ _L			260		According to JEDEC J-STD-020	
Mounting Torque	M _D			1 8.8	Nm Ibf-in	M3 or 6-32 screw	

Note (1): Recommended turn-on gate voltage is 15V with ±5% regulation tolerance, see Application Note PRD-04814 for additional details Note (2): Verified by design

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Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions	Note	
Drain-Source Breakdown Voltage	V _{(BR)DSS}	650	_	_		$V_{GS} = 0 V, I_{D} = 100 \mu A$		
		1.8	2.3	3.6	v	$V_{DS} = V_{GS}$, $I_D = 1.86$ mA	- Fig. 11	
Gate Threshold Voltage	V _{GS(th)}	_	1.9	_		$V_{DS} = V_{GS}$, $I_D = 1.86$ mA, $T_J = 175^{\circ}C$		
Zero Gate Voltage Drain Current	I _{DSS}	_	1	50	μA	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$		
Gate-Source Leakage Current	I _{GSS}	_	10	250	nA	$V_{GS} = 15 V, V_{DS} = 0 V$		
Drain-Source On-State Resistance	P	_	120	157	mΩ	$V_{GS} = 15 \text{ V}, \text{ I}_{D} = 6.76 \text{ A}$	Fig.	
	R _{DS(on)}	_	168	_	11122	$V_{GS} = 15 \text{ V}, I_D = 6.76 \text{ A}, T_J = 175^{\circ}\text{C}$	4, 5, 6	
Transconductance			5.0		S	$V_{DS} = 20 \text{ V}, \text{ I}_{DS} = 6.76 \text{ A}$	F :- 7	
Transconductance	g _{fs}	_	4.9		3	$V_{DS} = 20 \text{ V}, \text{ I}_{DS} = 6.76 \text{ A}, \text{ T}_{J} = 175^{\circ}\text{C}$	Fig. 7	
Input Capacitance	C _{iss}	_	640	_		V _{GS} = 0 V, V _{DS} = 0 V to 400 V	Fig. 17, 18	
Output Capacitance	C _{oss}	_	45	_		f = 1 Mhz		
Reverse Transfer Capacitance	C _{rss}	_	2.3	_	pF	V _{AC} = 25 mV		
Effective Output Capacitance (Energy Related)	C _{o(er)}	_	57	_			Note 3	
Effective Output Capacitance (Time Related)	C _{o(tr)}	_	79	_		$V_{GS} = 0 V, V_{DS} = 0 V \text{ to } 400 V$		
C _{oss} Stored Energy	E _{oss}	_	4.3	_		$V_{DS} = 400 V, f = 1 Mhz$	Fig. 16	
Turn-On Switching Energy (Body Diode)	Eon	_	71	_		$V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_{D} = 6.76 \text{ A},$	— Fig. 25	
Turn Off Switching Energy (Body Diode)	E _{off}	_	8	_	μJ	$R_{G(ext)} = 10 \Omega$, L= 237 μ H, T _J = 175°C FWD = Internal Body Diode of MOSFET		
Turn-On Switching Energy (External Diode)	Eon	_	57	_		$V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_{D} = 6.76 \text{ A},$		
Turn Off Switching Energy (External Diode)	E _{off}	_	7	_		$R_{G(ext)} = 10 \Omega$, L= 237 μ H, T _J = 175°C FWD = External SiC DIODE		
Turn-On Delay Time	t _{d(on)}	_	7	_			Fig. 26	
Rise Time	tr	_	17	_		$V_{DD} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$ $I_D = 6.76 \text{ A}, R_{G(ext)} = 10 \Omega$		
Turn-Off Delay Time	t _{d(off)}	_	13	_	ns	Timing relative to V _{DS}		
Fall Time	t _f	_	8	_		Inductive load		
Internal Gate Resistance	R _{G(int)}	_	6	_	Ω	<i>f</i> = 1 MHz, V _{AC} = 25 mV		
Gate to Source Charge	Q _{gs}	_	7	_			1	
Gate to Drain Charge	Q _{gd}	_	11	_	nC	$V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$ $I_D = 6.76 \text{ A}$	Fig. 12	
Total Gate Charge	Qg	_	28	_		Per IEC60747-8-4 pg 21		

Note:

 3 C_{o(er)}, a lumped capacitance that gives same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V C_{o(tr)}, a lumped capacitance that gives same charging time as C_{oss} while V_{DS} is rising from 0 to 400V

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Reverse Diode Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Тур.	Max.	Unit	Test Conditions	Notes
		4.5	-	v	$V_{GS} = -4 V$, $I_{SD} = 3.4 A$, $T_{J} = 25^{\circ}C$	Fig.
Diode Forward Voltage	V _{SD}	4.0	_		$V_{GS} = -4 V$, $I_{SD} = 3.4 A$, $T_{J} = 175^{\circ}C$	8,9,10
Continuous Diode Forward Current	Is	_	16		V _{GS} = -4 V, T _C = 25°C	
Diode pulse Current	I _{SM}	_	51	A	V _{GS} = -4 V, pulse width t _P limited by T _{jmax}	
Reverse Recovery Time	t _{rr}	18	-	ns		
Reverse Recovery Charge	Qrr	81	_	nC	$V_{GS} = -4 V, I_{SD} = 6.76 A, V_{R} = 400 V$ di ₂ /dt = 2160 A/ μ s, T _J = 175°C	
Peak Reverse Recovery Current	I _{RRM}	7	_	A		
Reverse Recovery Time	t _{rr}	25	_	ns		
Reverse Recovery Charge	Qrr	76	-	nC	$V_{GS} = -4 V, I_{SD} = 6.76 A, V_{R} = 400 V$ $di_{e}/dt = 900 A/\mu s, T_{J} = 175^{\circ}C$	
Peak Reverse Recovery Current	I _{RRM}	4	_	A	μ	

Thermal Characteristics

Parameter	Symbol	Тур.	Unit	Note
Thermal Resistance from Junction to Case	R _{θJC}	1.53		
Thermal Resistance From Junction to Ambient	R _{0JA}	40	°C/W	Fig. 21



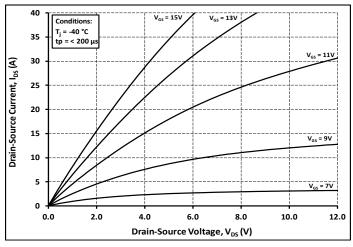


Figure 1. Output Characteristics T_J = -40°C

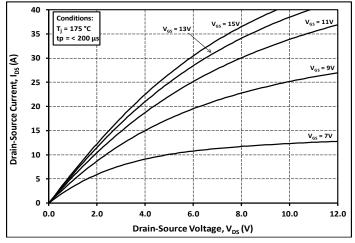
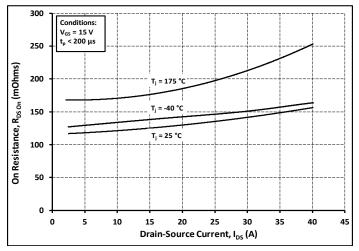
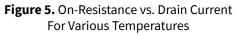
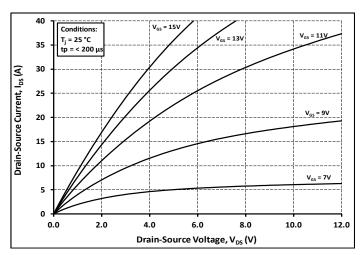


Figure 3. Output Characteristics T_J = 175°C









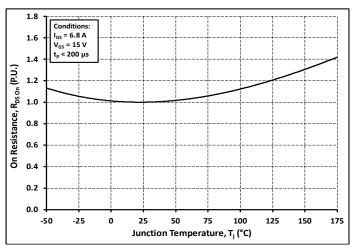


Figure 4. Normalized On-Resistance vs. Temperature

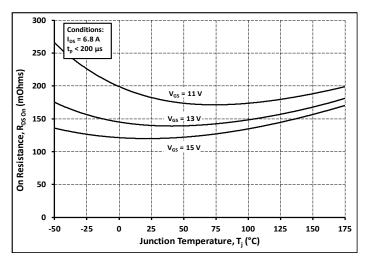
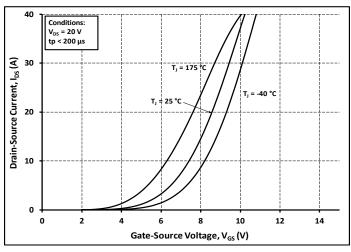


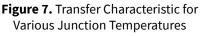
Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

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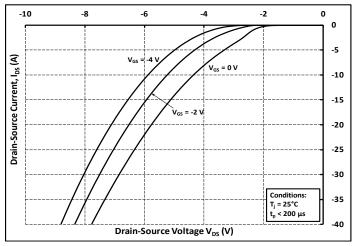


Figure 9. Body Diode Characteristic at 25°C

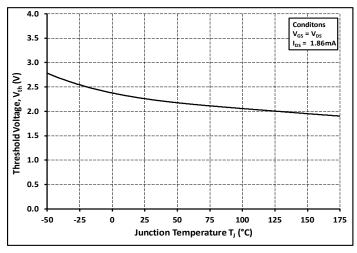


Figure 11. Threshold Voltage vs. Temperature

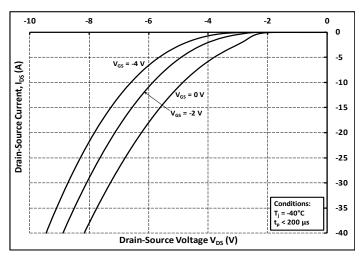


Figure 8. Body Diode Characteristic at -40°C

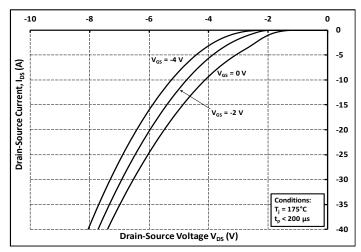


Figure 10. Body Diode Characteristic at 175°C

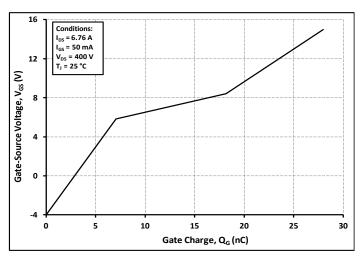


Figure 12. Gate Charge Characteristics

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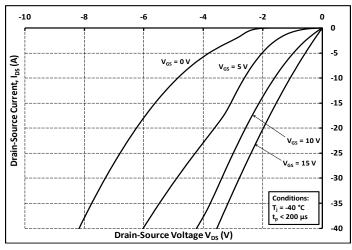


Figure 13. 3rd Quadrant Characteristic at -40°C

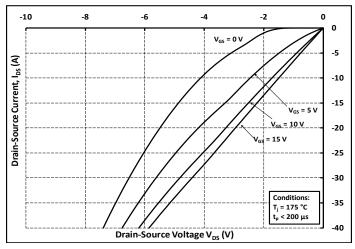
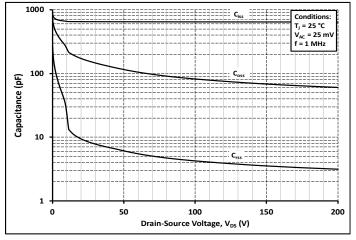
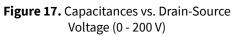


Figure 15. 3rd Quadrant Characteristic at 175°C





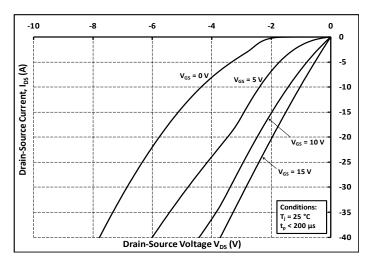


Figure 14. 3rd Quadrant Characteristic at 25°C

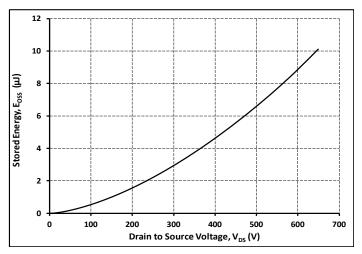


Figure 16. Output Capacitor Stored Energy

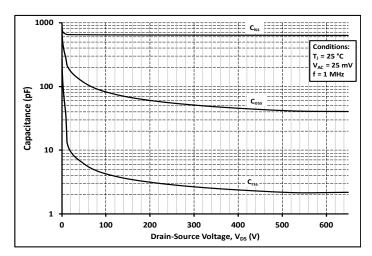
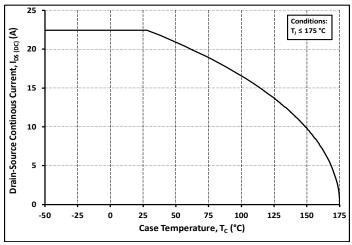


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 650 V)

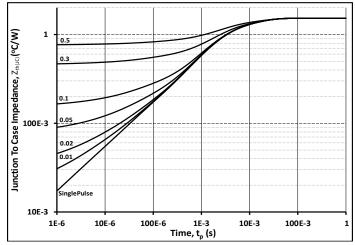
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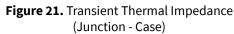
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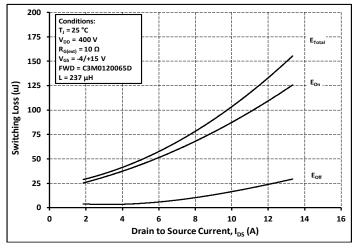


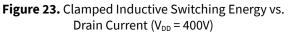












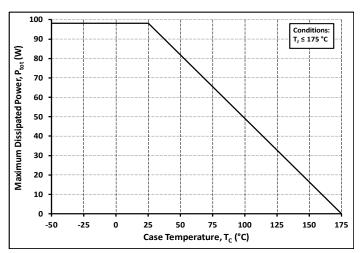


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

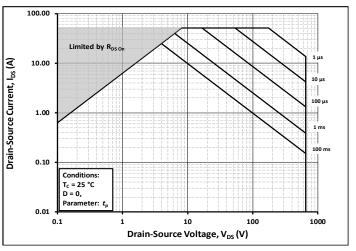
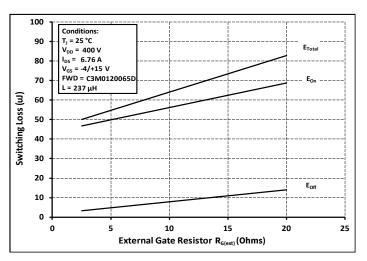
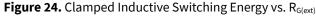


Figure 22. Safe Operating Area





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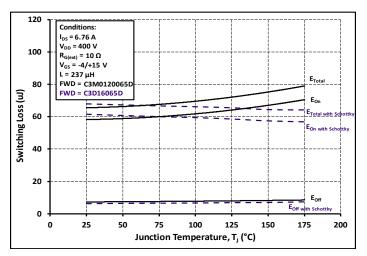


Figure 25. Clamped Inductive Switching Energy vs. Temperature

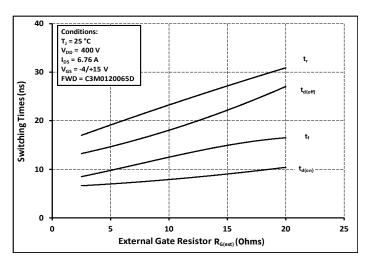


Figure 26. Switching Times vs. $R_{\mbox{\tiny G(ext)}}$



Test Circuit Schematic

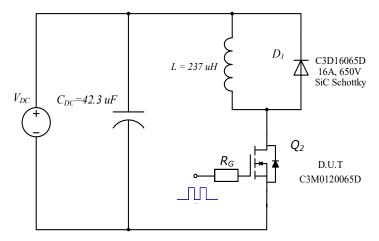


Figure 27. Clamped Inductive Switching Waveform Test Circuit

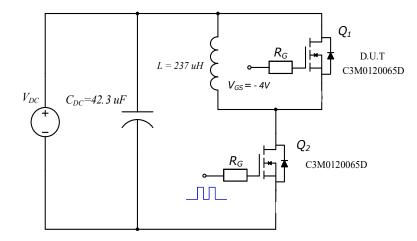
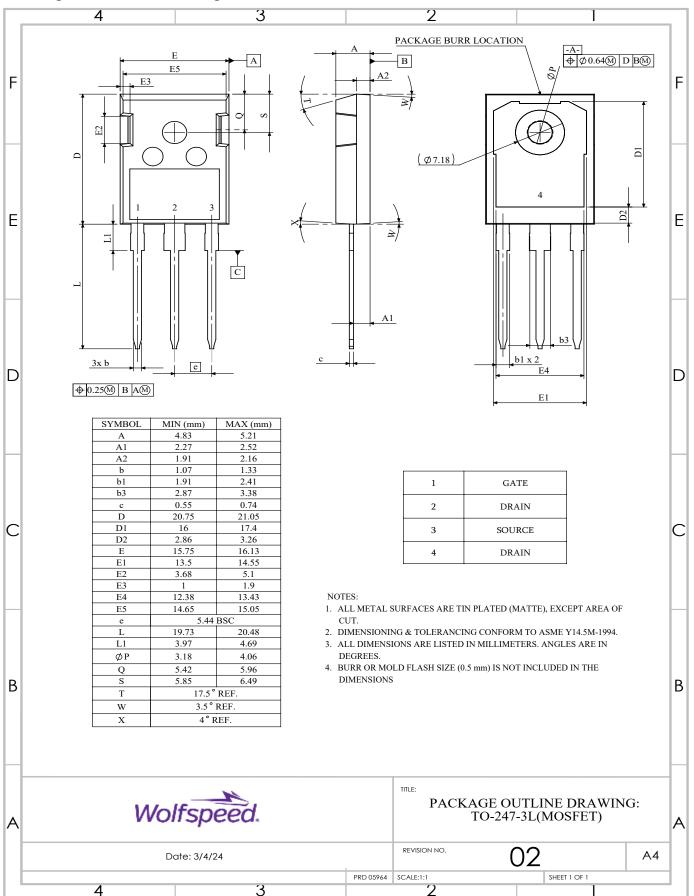


Figure 28. Body Diode Recovery Test Circuit

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Package Dimensions - Package TO 247 3

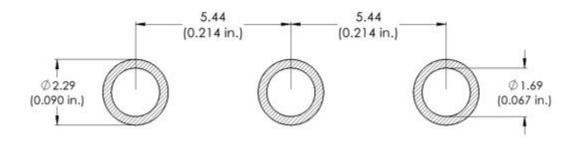


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Recommended Solder Pad Layout



Revision History

Current Revision	Date of Release	Description of Changes
1	January-2021	N/A
2	November-2023	Not Released
3	December-2023	Updated Wolfspeed branding, package drawing, package image, and solder pad layout, added Revision History Table, Table 1 layout revised
4	September - 2024	Legal Disclaimer, POD, Diode Pulse Current Symbol

Related Links

- SPICE Models
- SiC MOSFET Isolated Gate Driver reference design
- SiC MOSFET Evaluation Board

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